

# STARPOWER

SEMICONDUCTOR

**IGBT**

## GD275MJS120L6S

**1200V/275A 3-level in one-package**

### General Description

STARPOWER IGBT Power Module provides ultra low conduction loss. They are designed for the applications such as 3-level-application.

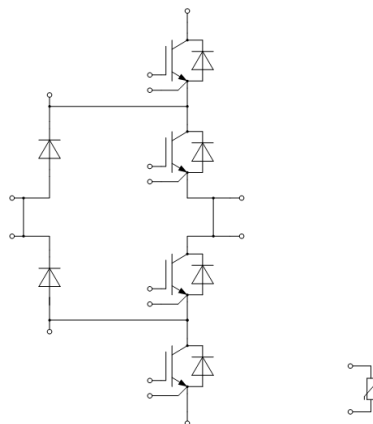
### Features

- Low  $V_{CE(sat)}$  Trench IGBT technology
- $V_{CE(sat)}$  with positive temperature coefficient
- Maximum junction temperature 175 °C
- Fast & soft reverse recovery anti-parallel FWD
- Isolated copper baseplate using  $Si_3N_4$  AMB technology

### Typical Applications

- Solar power
- 3-level-application

### Equivalent Circuit Schematic



**Absolute Maximum Ratings**  $T_C=25^{\circ}\text{C}$  unless otherwise noted**T1-T4 IGBT**

| Symbol    | Description                                   | Value    | Unit |
|-----------|---|----------|------|
| $V_{CES}$ | Collector-Emitter Voltage                     | 1200     | V    |
| $V_{GES}$ | Gate-Emitter Voltage                          | $\pm 20$ | V    |
| $I_{CN}$  | Implemented Collector Current                 | 275      | A    |
| $I_C$     | Collector Current @ $T_C=100^{\circ}\text{C}$ | 110      | A    |
| $I_{CM}$  | Pulsed Collector Current $t_p=1\text{ms}$     | 450      | A    |

**D1/D4 Diode**

| Symbol    | Description                                    | Value | Unit |
|-----------|--|-------|------|
| $V_{RRM}$ | Repetitive Peak Reverse Voltage                | 1200  | V    |
| $I_{FN}$  | Implemented Forward Current                    | 275   | A    |
| $I_F$     | Diode Continuous Forward Current               | 300   | A    |
| $I_{FM}$  | Diode Maximum Forward Current $t_p=1\text{ms}$ | 450   | A    |

**D2/D3 Diode**

| Symbol    | Description                                    | Value | Unit |
|-----------|--|-------|------|
| $V_{RRM}$ | Repetitive Peak Reverse Voltage                | 1200  | V    |
| $I_{FN}$  | Implemented Forward Current                    | 275   | A    |
| $I_F$     | Diode Continuous Forward Current               | 225   | A    |
| $I_{FM}$  | Diode Maximum Forward Current $t_p=1\text{ms}$ | 450   | A    |

**D5/D6 Diode**

| Symbol    | Description                                    | Value | Unit |
|-----------|--|-------|------|
| $V_{RRM}$ | Repetitive Peak Reverse Voltage                | 1200  | V    |
| $I_{FN}$  | Implemented Forward Current                    | 275   | A    |
| $I_F$     | Diode Continuous Forward Current               | 300   | A    |
| $I_{FM}$  | Diode Maximum Forward Current $t_p=1\text{ms}$ | 450   | A    |

**Module**

| Symbol     | Description   | Value       | Unit               |
|------------|---|-------------|--------------------|
| $T_{jmax}$ | Maximum Junction Temperature                          | 175         | $^{\circ}\text{C}$ |
| $T_{jop}$  | Operating Junction Temperature                        | -40 to +150 | $^{\circ}\text{C}$ |
| $T_{STG}$  | Storage Temperature Range                             | -40 to +125 | $^{\circ}\text{C}$ |
| $V_{ISO}$  | Isolation Voltage RMS, $f=50\text{Hz}, t=1\text{min}$ | 3200        | V                  |

**T1/T4 IGBT Characteristics**  $T_C=25^\circ\text{C}$  unless otherwise noted

| Symbol        | Parameter                               | Test Conditions   | Min. | Typ. | Max. | Unit          |
|---------------|---|---|------|------|------|---------------|
| $V_{CE(sat)}$ | Collector to Emitter Saturation Voltage | $I_C=225\text{A}, V_{GE}=15\text{V}, T_j=25^\circ\text{C}$  |      | 2.00 | 2.45 | V             |
|               |   | $I_C=225\text{A}, V_{GE}=15\text{V}, T_j=125^\circ\text{C}$   |      | 2.70 |      |               |
|               |   | $I_C=225\text{A}, V_{GE}=15\text{V}, T_j=150^\circ\text{C}$   |      | 2.90 |      |               |
| $V_{GE(th)}$  | Gate-Emitter Threshold Voltage          | $I_C=9.00\text{mA}, V_{CE}=V_{GE}, T_j=25^\circ\text{C}$  | 5.6  | 6.2  | 6.8  | V             |
| $I_{CES}$     | Collector Cut-Off Current               | $V_{CE}=V_{CES}, V_{GE}=0\text{V}, T_j=25^\circ\text{C}$  |      |      | 1.0  | mA            |
| $I_{GES}$     | Gate-Emitter Leakage Current            | $V_{GE}=V_{GES}, V_{CE}=0\text{V}, T_j=25^\circ\text{C}$  |      |      | 400  | nA            |
| $R_{Gint}$    | Internal Gate Resistance                |   |      | 1.7  |      | $\Omega$      |
| $C_{ies}$     | Input Capacitance                       | $V_{CE}=25\text{V}, f=100\text{kHz}, V_{GE}=0\text{V}$  |      | 38.1 |      | nF            |
| $C_{res}$     | Reverse Transfer Capacitance            |   |      | 0.66 |      | nF            |
| $Q_G$         | Gate Charge                             | $V_{GE}=-15\dots+15\text{V}$  |      | 2.52 |      | $\mu\text{C}$ |
| $t_{d(on)}$   | Turn-On Delay Time                      | $V_{CC}=600\text{V}, I_C=225\text{A}, R_G=2\Omega, V_{GE}=-8/+15\text{V}, L_S=36\text{nH}, T_j=25^\circ\text{C}$  |      | 154  |      | ns            |
| $t_r$         | Rise Time                               |   |      | 45   |      | ns            |
| $t_{d(off)}$  | Turn-Off Delay Time                     |   |      | 340  |      | ns            |
| $t_f$         | Fall Time                               |   |      | 76   |      | ns            |
| $E_{on}$      | Turn-On Switching Loss                  |   |      | 13.4 |      | mJ            |
| $E_{off}$     | Turn-Off Switching Loss                 |   |      | 8.08 |      | mJ            |
| $t_{d(on)}$   | Turn-On Delay Time                      | $V_{CC}=600\text{V}, I_C=225\text{A}, R_G=2\Omega, V_{GE}=-8/+15\text{V}, L_S=36\text{nH}, T_j=125^\circ\text{C}$ |      | 160  |      | ns            |
| $t_r$         | Rise Time                               |   |      | 49   |      | ns            |
| $t_{d(off)}$  | Turn-Off Delay Time                     |   |      | 388  |      | ns            |
| $t_f$         | Fall Time                               |   |      | 112  |      | ns            |
| $E_{on}$      | Turn-On Switching Loss                  |   |      | 17.6 |      | mJ            |
| $E_{off}$     | Turn-Off Switching Loss                 |   |      | 11.2 |      | mJ            |
| $t_{d(on)}$   | Turn-On Delay Time                      | $V_{CC}=600\text{V}, I_C=225\text{A}, R_G=2\Omega, V_{GE}=-8/+15\text{V}, L_S=36\text{nH}, T_j=150^\circ\text{C}$ |      | 163  |      | ns            |
| $t_r$         | Rise Time                               |   |      | 51   |      | ns            |
| $t_{d(off)}$  | Turn-Off Delay Time                     |   |      | 397  |      | ns            |
| $t_f$         | Fall Time                               |   |      | 114  |      | ns            |
| $E_{on}$      | Turn-On Switching Loss                  |   |      | 18.7 |      | mJ            |
| $E_{off}$     | Turn-Off Switching Loss                 |   |      | 12.0 |      | mJ            |

**T2/T3 IGBT Characteristics**  $T_C=25^\circ\text{C}$  unless otherwise noted

| Symbol        | Parameter                               | Test Conditions   | Min. | Typ. | Max. | Unit          |
|---------------|---|---|------|------|------|---------------|
| $V_{CE(sat)}$ | Collector to Emitter Saturation Voltage | $I_C=225\text{A}, V_{GE}=15\text{V}, T_j=25^\circ\text{C}$  |      |      | 2.45 | V             |
|               |   | $I_C=225\text{A}, V_{GE}=15\text{V}, T_j=125^\circ\text{C}$   |      |      |      |               |
|               |   | $I_C=225\text{A}, V_{GE}=15\text{V}, T_j=150^\circ\text{C}$   |      |      |      |               |
| $V_{GE(th)}$  | Gate-Emitter Threshold Voltage          | $I_C=9.00\text{mA}, V_{CE}=V_{GE}, T_j=25^\circ\text{C}$  | 5.6  |      | 6.8  | V             |
| $I_{CES}$     | Collector Cut-Off Current               | $V_{CE}=V_{CES}, V_{GE}=0\text{V}, T_j=25^\circ\text{C}$  |      |      | 1.0  | mA            |
| $I_{GES}$     | Gate-Emitter Leakage Current            | $V_{GE}=V_{GES}, V_{CE}=0\text{V}, T_j=25^\circ\text{C}$  |      |      | 400  | nA            |
| $R_{Gint}$    | Internal Gate Resistance                |   |      |      |      | $\Omega$      |
| $C_{ies}$     | Input Capacitance                       | $V_{CE}=25\text{V}, f=100\text{kHz}, V_{GE}=0\text{V}$  |      |      |      | nF            |
| $C_{res}$     | Reverse Transfer Capacitance            |   |      |      |      | nF            |
| $Q_G$         | Gate Charge                             | $V_{GE}=-15\dots+15\text{V}$  |      |      |      | $\mu\text{C}$ |
| $t_{d(on)}$   | Turn-On Delay Time                      | $V_{CC}=600\text{V}, I_C=225\text{A}, R_G=2\Omega, V_{GE}=-8/+15\text{V}, L_S=36\text{nH}, T_j=25^\circ\text{C}$  |      | 153  |      | ns            |
| $t_r$         | Rise Time                               |   |      | 46   |      | ns            |
| $t_{d(off)}$  | Turn-Off Delay Time                     |   |      | 280  |      | ns            |
| $t_f$         | Fall Time                               |   |      | 145  |      | ns            |
| $E_{on}$      | Turn-On Switching Loss                  |   |      | 13.5 |      | mJ            |
| $E_{off}$     | Turn-Off Switching Loss                 |   |      | 6.35 |      | mJ            |
| $t_{d(on)}$   | Turn-On Delay Time                      | $V_{CC}=600\text{V}, I_C=225\text{A}, R_G=2\Omega, V_{GE}=-8/+15\text{V}, L_S=36\text{nH}, T_j=125^\circ\text{C}$ |      | 157  |      | ns            |
| $t_r$         | Rise Time                               |   |      | 50   |      | ns            |
| $t_{d(off)}$  | Turn-Off Delay Time                     |   |      | 349  |      | ns            |
| $t_f$         | Fall Time                               |   |      | 123  |      | ns            |
| $E_{on}$      | Turn-On Switching Loss                  |   |      | 16.9 |      | mJ            |
| $E_{off}$     | Turn-Off Switching Loss                 |   |      | 8.85 |      | mJ            |
| $t_{d(on)}$   | Turn-On Delay Time                      | $V_{CC}=600\text{V}, I_C=225\text{A}, R_G=2\Omega, V_{GE}=-8/+15\text{V}, L_S=36\text{nH}, T_j=150^\circ\text{C}$ |      | 159  |      | ns            |
| $t_r$         | Rise Time                               |   |      | 50   |      | ns            |
| $t_{d(off)}$  | Turn-Off Delay Time                     |   |      | 363  |      | ns            |
| $t_f$         | Fall Time                               |   |      | 196  |      | ns            |
| $E_{on}$      | Turn-On Switching Loss                  |   |      | 18.1 |      | mJ            |
| $E_{off}$     | Turn-Off Switching Loss                 |   |      | 9.52 |      | mJ            |

**D1/D4 Diode Characteristics**  $T_C=25^\circ\text{C}$  unless otherwise noted

| Symbol    | Parameter                     | Test Conditions   | Min. | Typ. | Max. | Unit          |
|-----------|-------------------------------|---|------|------|------|---------------|
| $V_F$     | Diode Forward Voltage         | $I_F=300\text{A}, V_{GE}=0\text{V}, T_j=25^\circ\text{C}$   |      | 1.60 | 2.05 | V             |
|           |                               | $I_F=300\text{A}, V_{GE}=0\text{V}, T_j=125^\circ\text{C}$  |      | 1.60 |      |               |
|           |                               | $I_F=300\text{A}, V_{GE}=0\text{V}, T_j=150^\circ\text{C}$  |      | 1.60 |      |               |
| $Q_r$     | Recovered Charge              | $V_R=600\text{V}, I_F=225\text{A},$<br>$-di/dt=5350\text{A}/\mu\text{s}, V_{GE}=-8\text{V}$<br>$L_S=36\text{nH}, T_j=25^\circ\text{C}$  |      | 20.1 |      | $\mu\text{C}$ |
| $I_{RM}$  | Peak Reverse Recovery Current |   |      | 250  |      | A             |
| $E_{rec}$ | Reverse Recovery Energy       |   |      | 6.84 |      | mJ            |
| $Q_r$     | Recovered Charge              | $V_R=600\text{V}, I_F=225\text{A},$<br>$-di/dt=5080\text{A}/\mu\text{s}, V_{GE}=-8\text{V}$<br>$L_S=36\text{nH}, T_j=125^\circ\text{C}$ |      | 32.5 |      | $\mu\text{C}$ |
| $I_{RM}$  | Peak Reverse Recovery Current |   |      | 277  |      | A             |
| $E_{rec}$ | Reverse Recovery Energy       |   |      | 11.5 |      | mJ            |
| $Q_r$     | Recovered Charge              | $V_R=600\text{V}, I_F=225\text{A},$<br>$-di/dt=4930\text{A}/\mu\text{s}, V_{GE}=-8\text{V}$<br>$L_S=36\text{nH}, T_j=150^\circ\text{C}$ |      | 39.0 |      | $\mu\text{C}$ |
| $I_{RM}$  | Peak Reverse Recovery Current |   |      | 288  |      | A             |
| $E_{rec}$ | Reverse Recovery Energy       |   |      | 14.0 |      | mJ            |

**D2/D3 Diode Characteristics**  $T_C=25^\circ\text{C}$  unless otherwise noted

| Symbol | Parameter             | Test Conditions  | Min. | Typ. | Max. | Unit |
|--------|-----------------------|--|------|------|------|------|
| $V_F$  | Diode Forward Voltage | $I_F=225\text{A}, V_{GE}=0\text{V}, T_j=25^\circ\text{C}$  |      | 1.60 | 2.05 | V    |
|        |                       | $I_F=225\text{A}, V_{GE}=0\text{V}, T_j=125^\circ\text{C}$ |      | 1.60 |      |      |
|        |                       | $I_F=225\text{A}, V_{GE}=0\text{V}, T_j=150^\circ\text{C}$ |      | 1.60 |      |      |

**D5/D6 Diode Characteristics**  $T_C=25^\circ\text{C}$  unless otherwise noted

| Symbol    | Parameter                     | Test Conditions   | Min. | Typ. | Max. | Unit          |
|-----------|-------------------------------|---|------|------|------|---------------|
| $V_F$     | Diode Forward Voltage         | $I_F=300\text{A}, V_{GE}=0\text{V}, T_j=25^\circ\text{C}$   |      | 1.60 | 2.05 | V             |
|           |                               | $I_F=300\text{A}, V_{GE}=0\text{V}, T_j=125^\circ\text{C}$  |      | 1.60 |      |               |
|           |                               | $I_F=300\text{A}, V_{GE}=0\text{V}, T_j=150^\circ\text{C}$  |      | 1.60 |      |               |
| $Q_r$     | Recovered Charge              | $V_R=600\text{V}, I_F=225\text{A},$<br>$-di/dt=5050\text{A}/\mu\text{s}, V_{GE}=-8\text{V}$<br>$L_S=30\text{nH}, T_j=25^\circ\text{C}$  |      | 18.6 |      | $\mu\text{C}$ |
| $I_{RM}$  | Peak Reverse Recovery Current |   |      | 189  |      | A             |
| $E_{rec}$ | Reverse Recovery Energy       |   |      | 5.62 |      | mJ            |
| $Q_r$     | Recovered Charge              | $V_R=600\text{V}, I_F=225\text{A},$<br>$-di/dt=4720\text{A}/\mu\text{s}, V_{GE}=-8\text{V}$<br>$L_S=30\text{nH}, T_j=125^\circ\text{C}$ |      | 34.1 |      | $\mu\text{C}$ |
| $I_{RM}$  | Peak Reverse Recovery Current |   |      | 250  |      | A             |
| $E_{rec}$ | Reverse Recovery Energy       |   |      | 11.4 |      | mJ            |
| $Q_r$     | Recovered Charge              | $V_R=600\text{V}, I_F=225\text{A},$<br>$-di/dt=4720\text{A}/\mu\text{s}, V_{GE}=-8\text{V}$<br>$L_S=30\text{nH}, T_j=150^\circ\text{C}$ |      | 38.9 |      | $\mu\text{C}$ |
| $I_{RM}$  | Peak Reverse Recovery Current |   |      | 265  |      | A             |
| $E_{rec}$ | Reverse Recovery Energy       |   |      | 13.2 |      | mJ            |

**NTC Characteristics**  $T_C=25^\circ\text{C}$  unless otherwise noted

| Symbol       | Parameter              | Test Conditions  | Min. | Typ. | Max. | Unit             |
|--------------|------------------------|--|------|------|------|------------------|
| $R_{25}$     | Rated Resistance       |  |      | 5.0  |      | $\text{k}\Omega$ |
| $\Delta R/R$ | Deviation of $R_{100}$ | $T_C=100^\circ\text{C}, R_{100}=493.3\Omega$           | -5   |      | 5    | %                |
| $P_{25}$     | Power Dissipation      |  |      |      | 20.0 | mW               |
| $B_{25/50}$  | B-value                | $R_2=R_{25}\exp[B_{25/50}(1/T_2-1/(298.15\text{K}))]$  |      | 3375 |      | K                |
| $B_{25/80}$  | B-value                | $R_2=R_{25}\exp[B_{25/80}(1/T_2-1/(298.15\text{K}))]$  |      | 3411 |      | K                |
| $B_{25/100}$ | B-value                | $R_2=R_{25}\exp[B_{25/100}(1/T_2-1/(298.15\text{K}))]$ |      | 3433 |      | K                |

**Module Characteristics**  $T_c=25^{\circ}\text{C}$  unless otherwise noted

| Symbol     | Parameter                          | Min. | Typ.  | Max.  | Unit |
|------------|------------------------------------|------|-------|-------|------|
| $L_{CE}$   | Stray Inductance                   |      | 15    |       | nH   |
| $R_{thJC}$ | Junction-to-Case (per T1-T4 IGBT)  |      |       | 0.070 | K/W  |
|            | Junction-to-Case (per D1/D4 Diode) |      |       | 0.122 |      |
|            | Junction-to-Case (per D2/D3 Diode) |      |       | 0.156 |      |
|            | Junction-to-Case (per D5/D6 Diode) |      |       | 0.122 |      |
| $R_{thCH}$ | Case-to-Heatsink (per T1-T4 IGBT)  |      | 0.043 |       | K/W  |
|            | Case-to-Heatsink (per D1/D4 Diode) |      | 0.053 |       |      |
|            | Case-to-Heatsink (per D2/D3 Diode) |      | 0.069 |       |      |
|            | Case-to-Heatsink (per D5/D6 Diode) |      | 0.053 |       |      |
| M          | Mounting Torque, Screw:M5          | 3.0  |       | 5.0   | N.m  |
| G          | Weight of Module                   |      | 250   |       | g    |

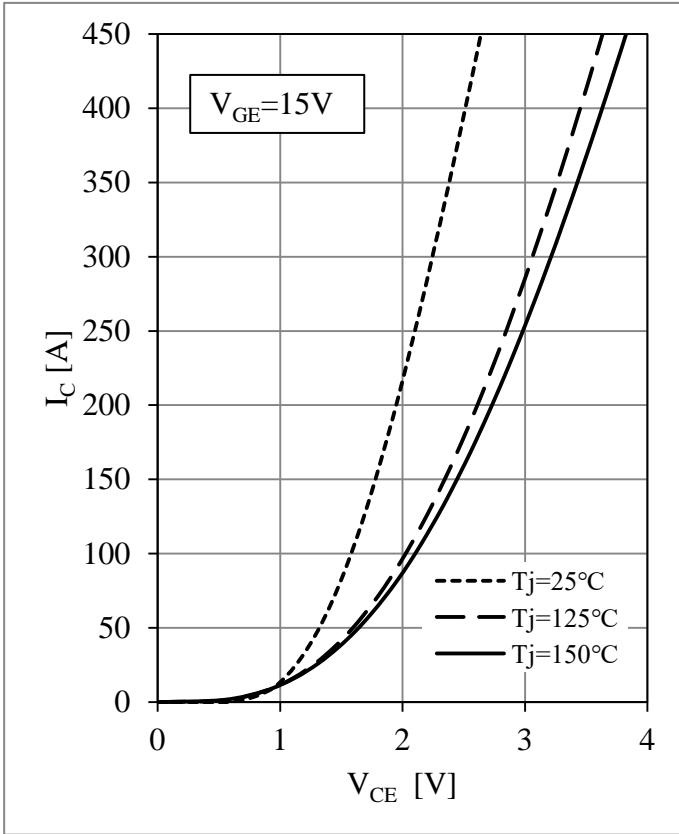


Fig 1. T1/T4 IGBT Output Characteristics

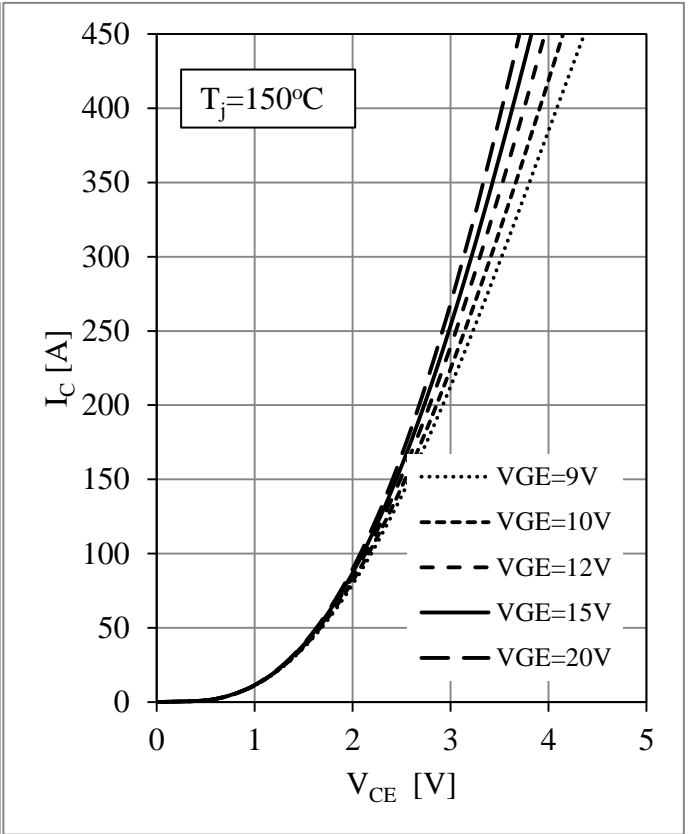


Fig 2. T1/T4 IGBT Output Characteristics

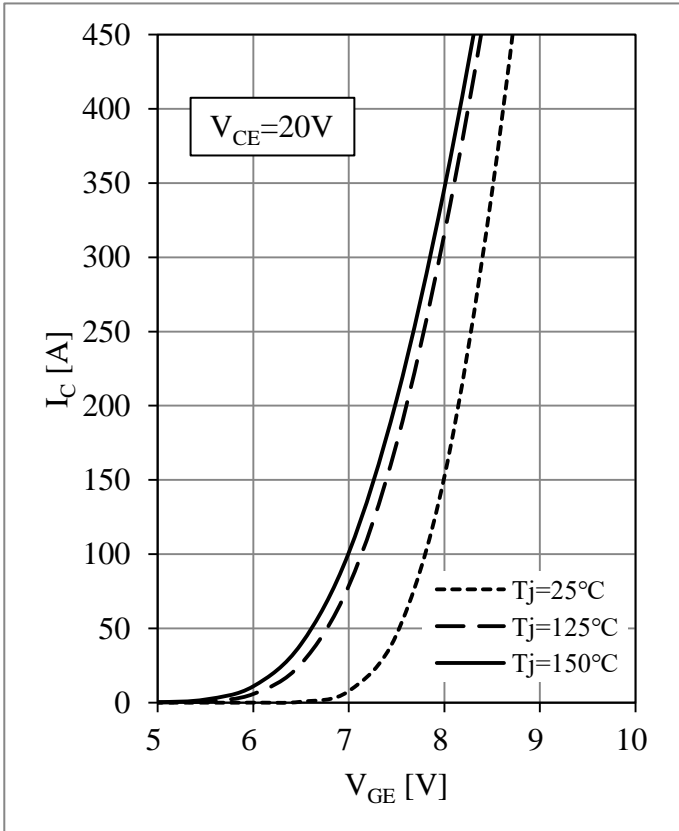


Fig 3. T1/T4 IGBT Transfer Characteristics

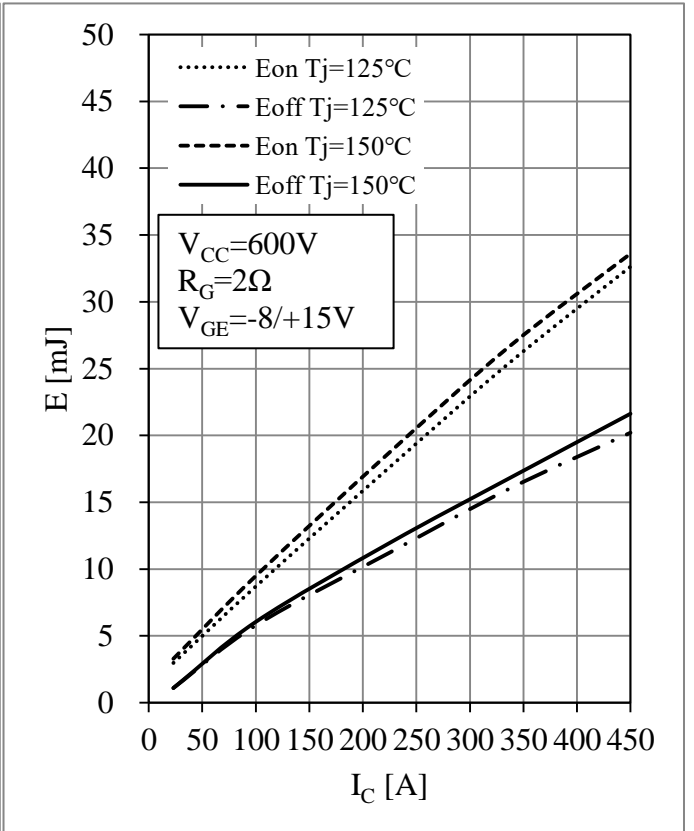


Fig 4. T1/T4 IGBT Switching Loss vs.  $I_C$



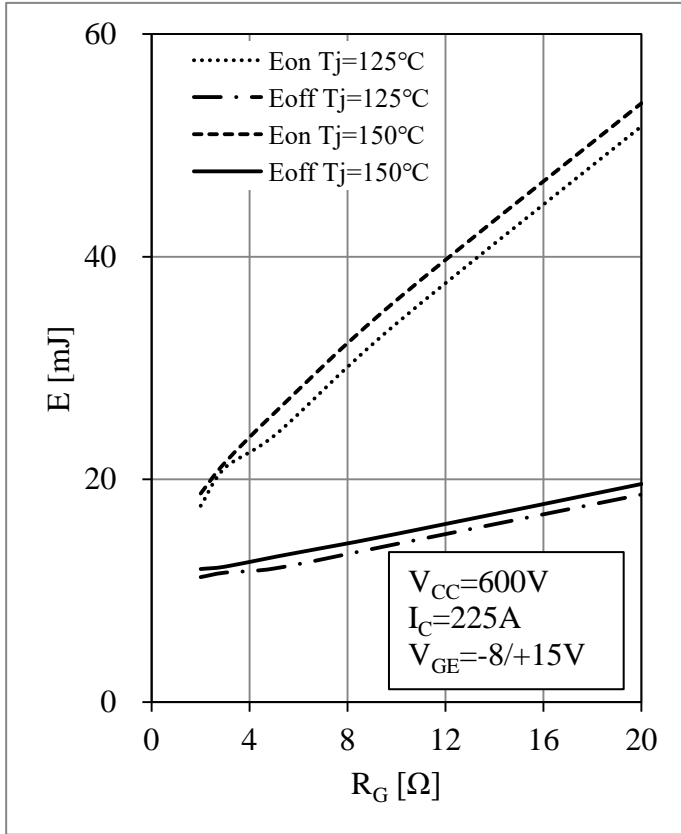


Fig 5. T1/T4 IGBT Switching Loss vs.  $R_G$

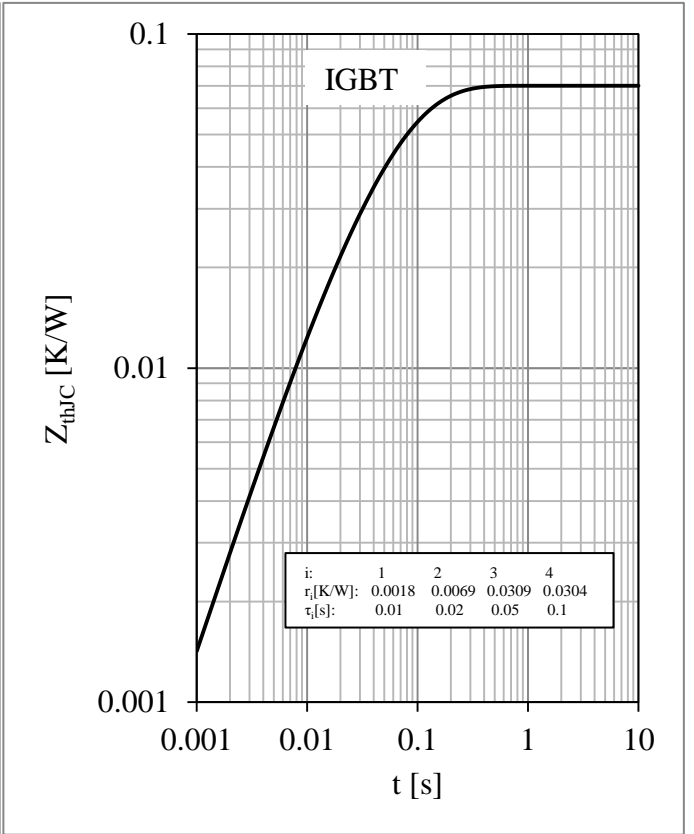


Fig 6. T1/T4 IGBT Transient Thermal Impedance

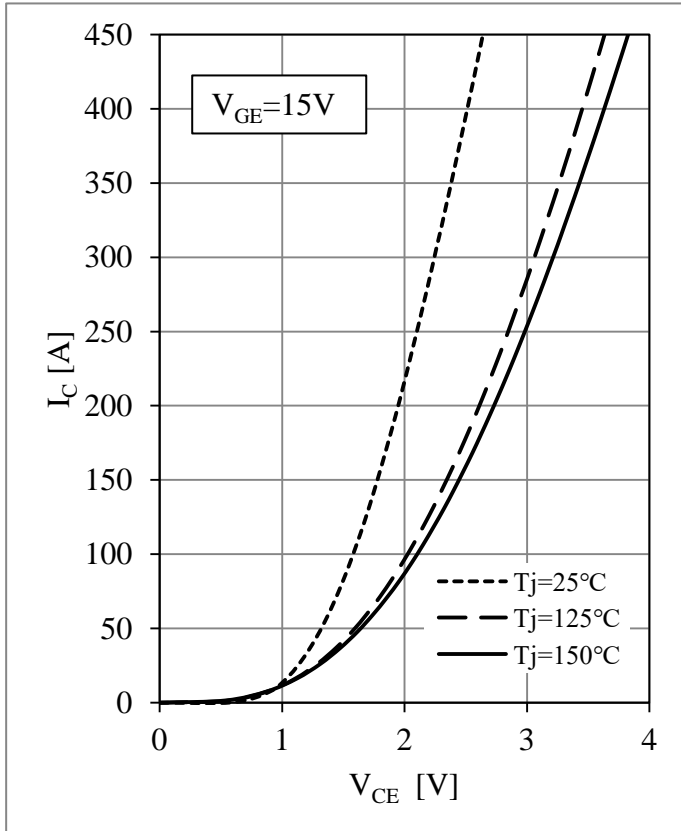


Fig 7. T2/T3 IGBT Output Characteristics

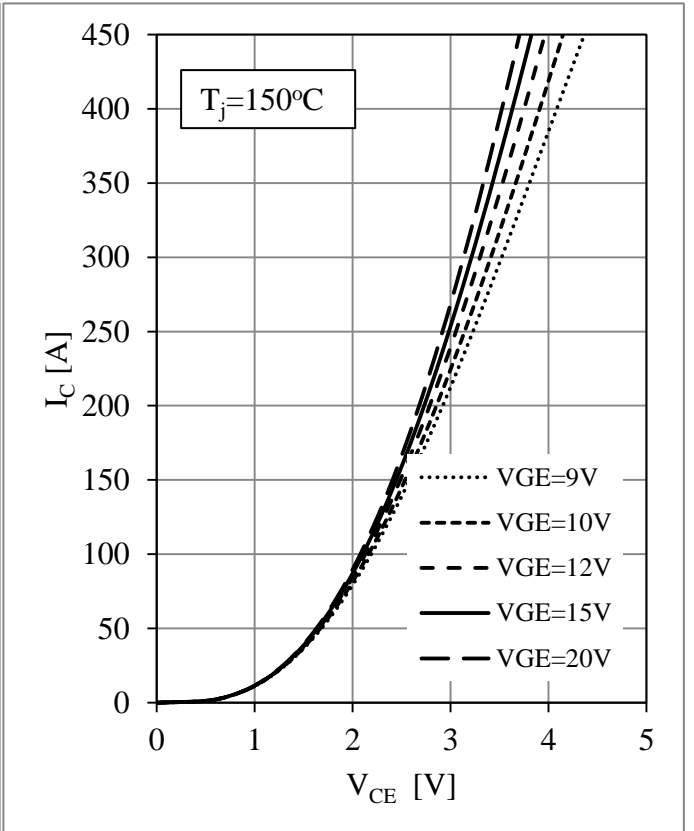


Fig 8. T2/T3 IGBT Output Characteristics

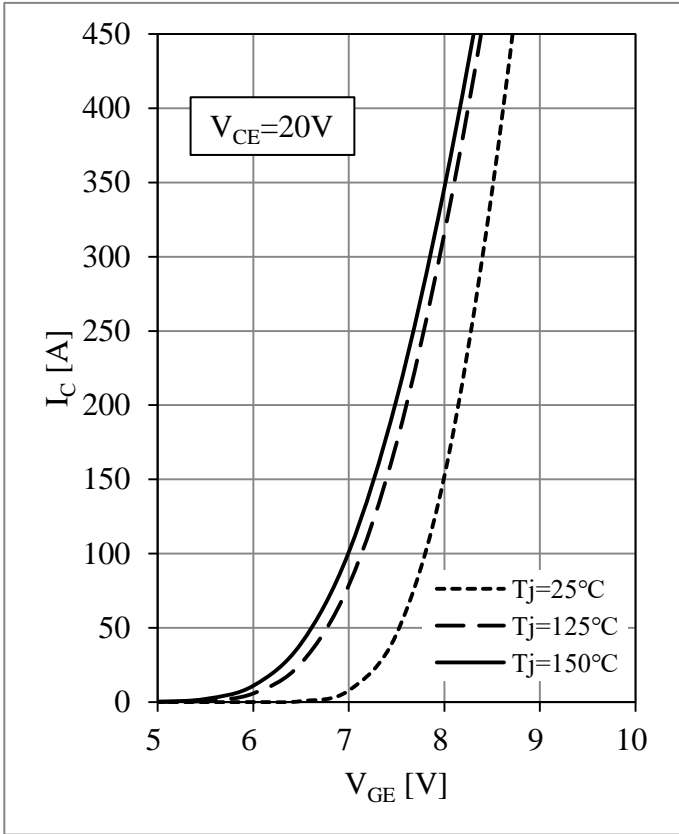


Fig 9. T2/T3 IGBT Transfer Characteristics

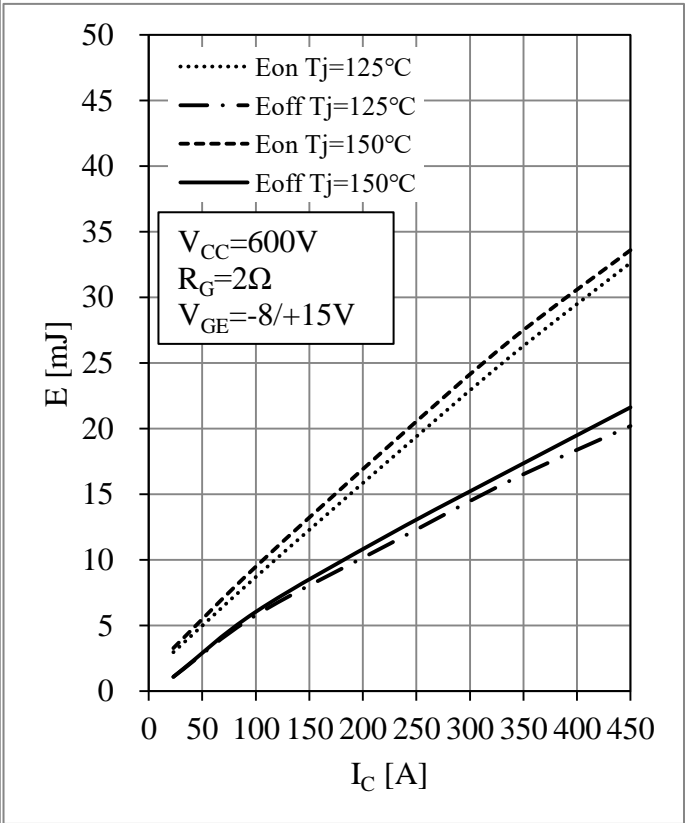


Fig 10. T2/T3 IGBT Switching Loss vs.  $I_c$

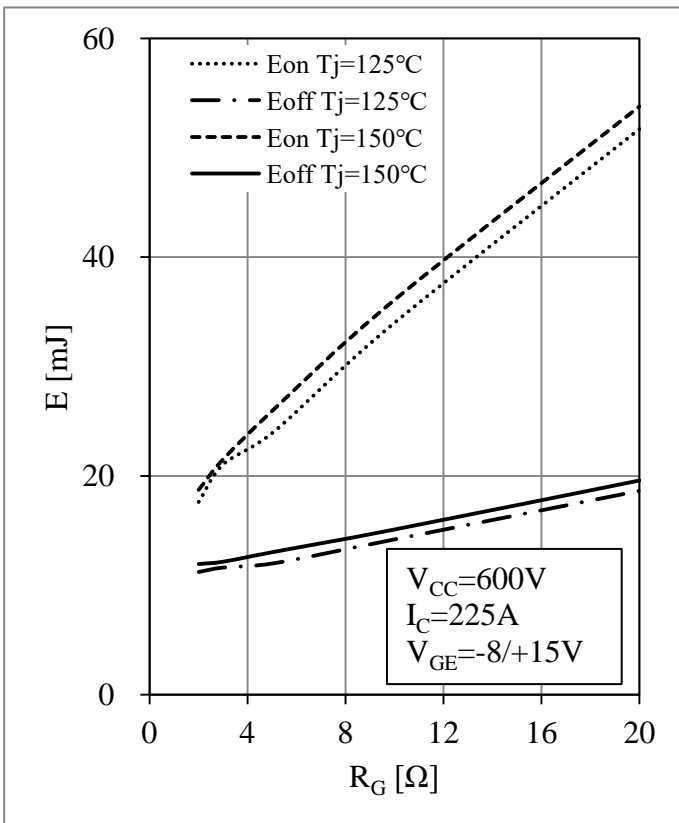


Fig 11. T2/T3 IGBT Switching Loss vs.  $R_G$

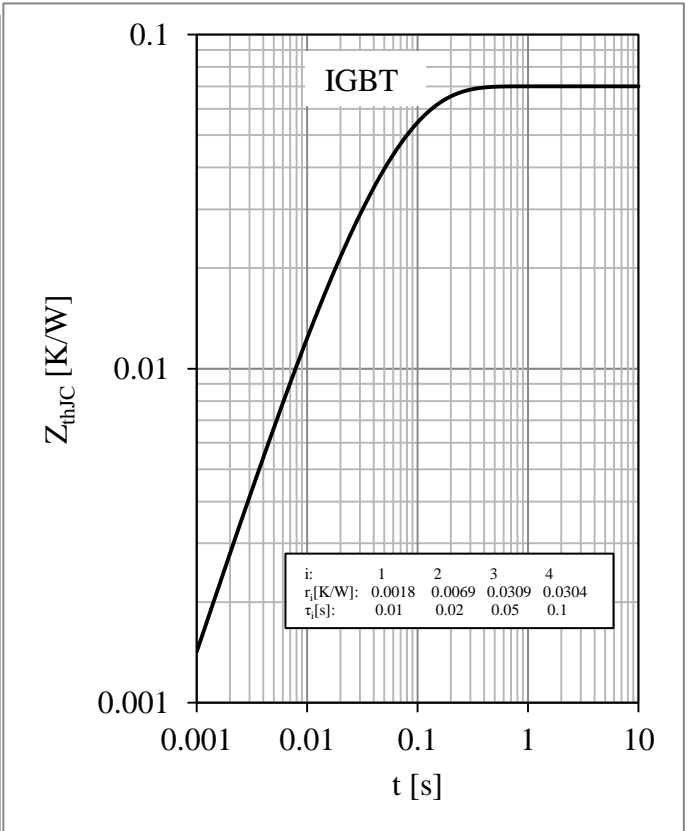


Fig 12. T2/T3 IGBT Transient Thermal Impedance

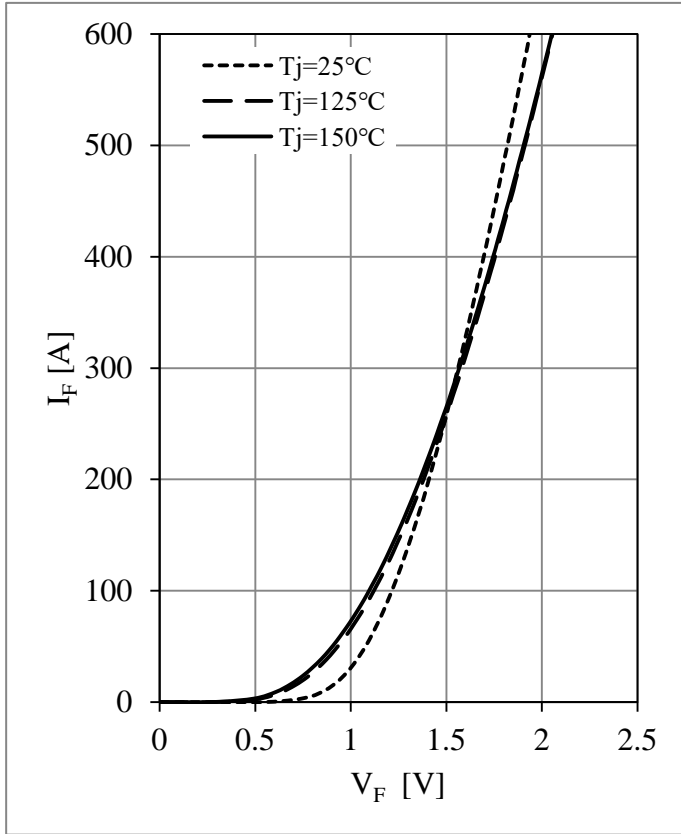


Fig 13. D1/D4 Diode Forward Characteristics

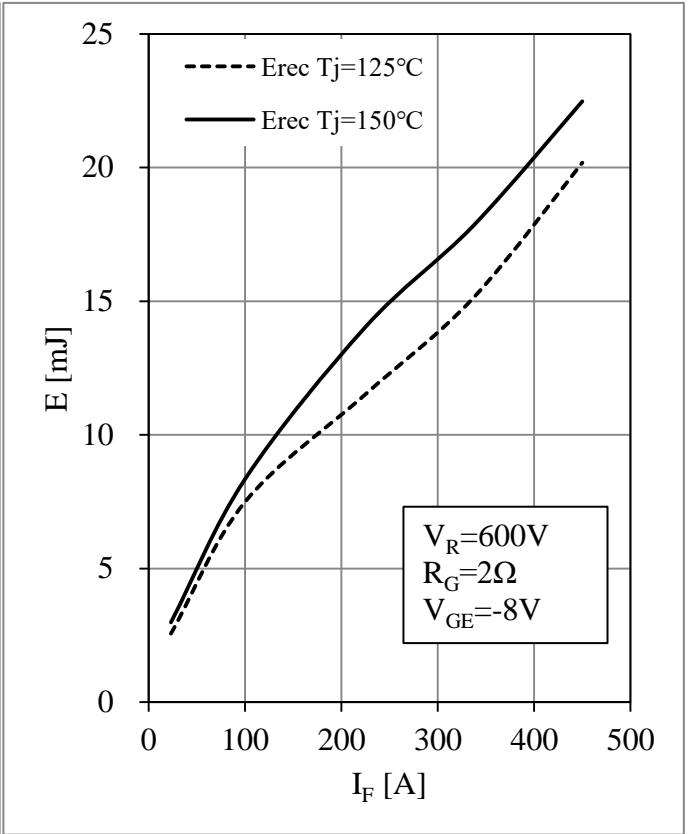


Fig 14. D1/D4 Diode Switching Loss vs.  $I_F$

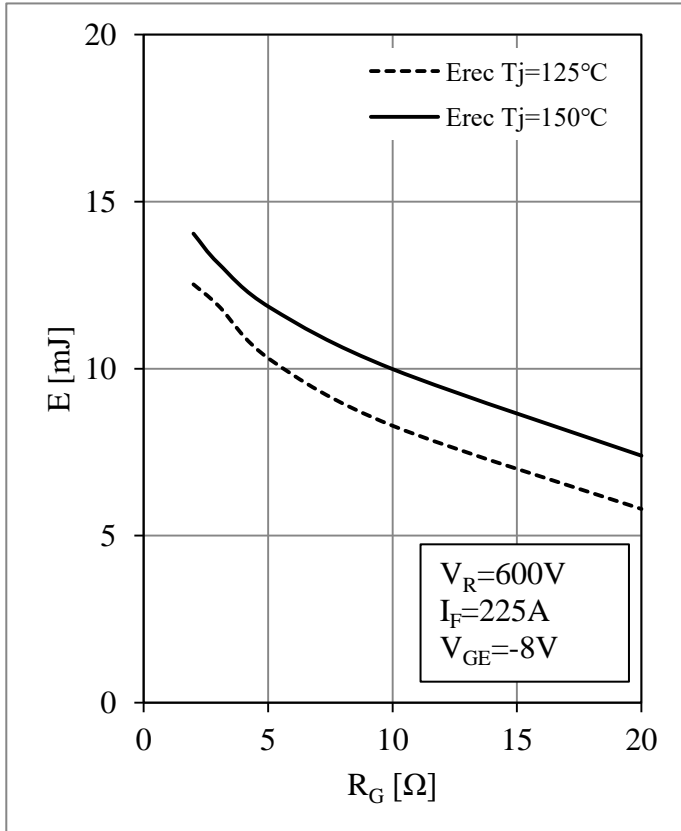


Fig 15. D1/D4 Diode Switching Loss vs.  $R_G$

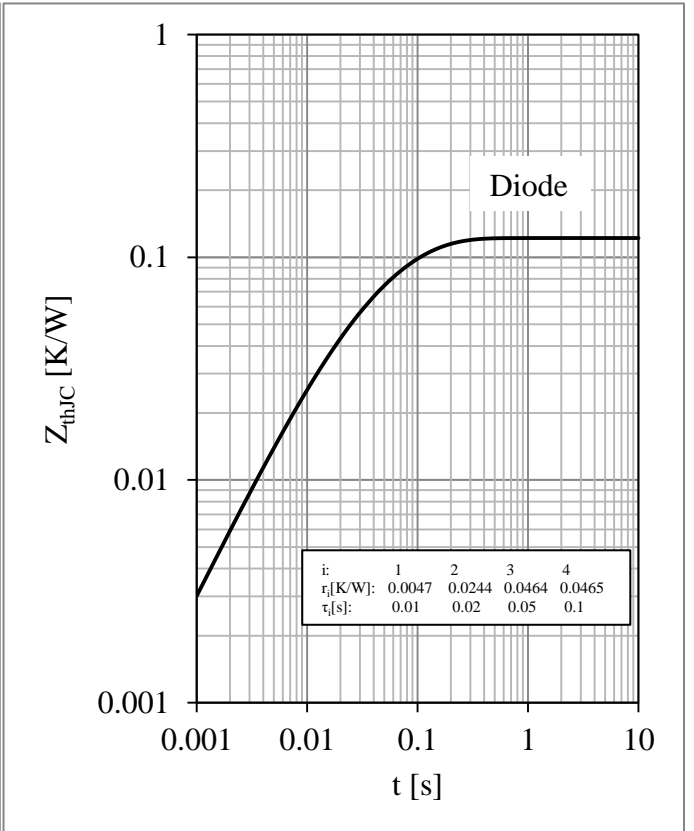


Fig 16. D1/D4 Diode Transient Thermal Impedance

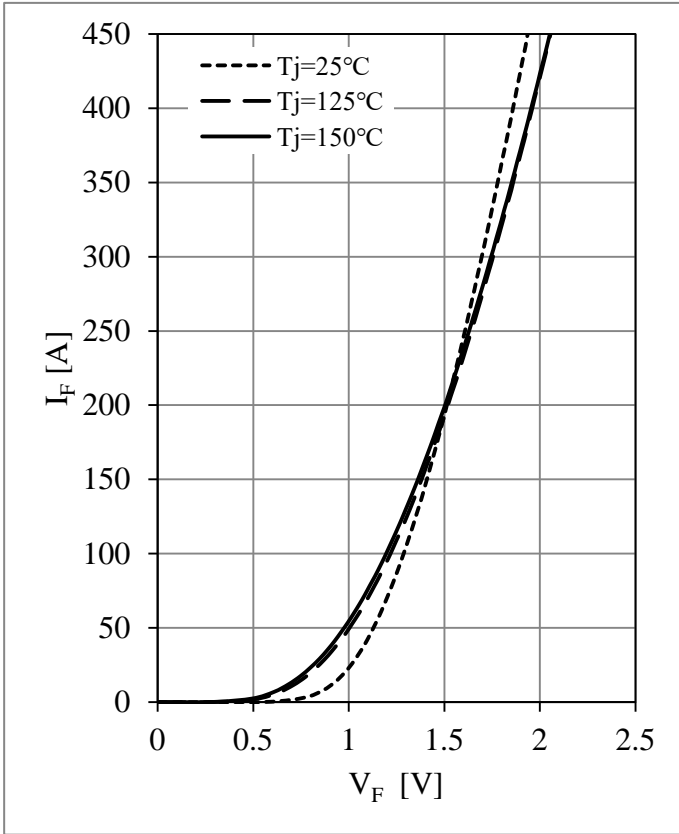


Fig 17. D2/D3 Diode Forward Characteristics

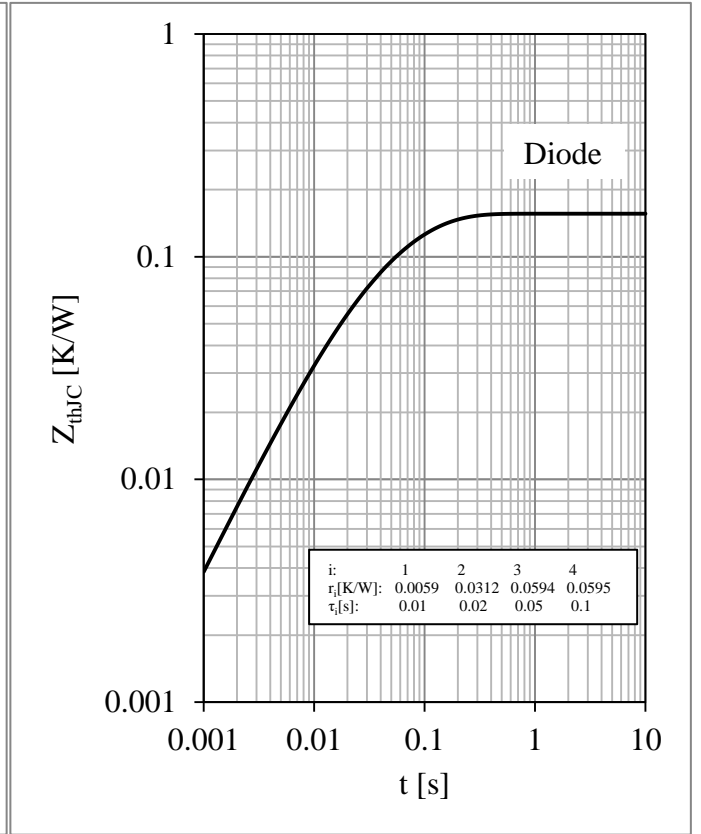


Fig 18. D2/D3 Diode Transient Thermal Impedance

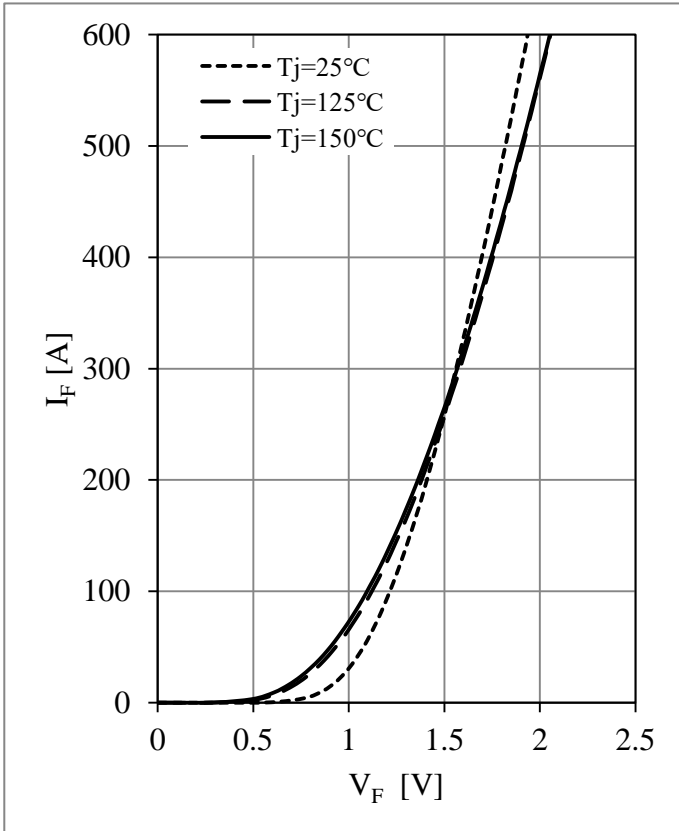


Fig 19. D5/D6 Diode Forward Characteristics

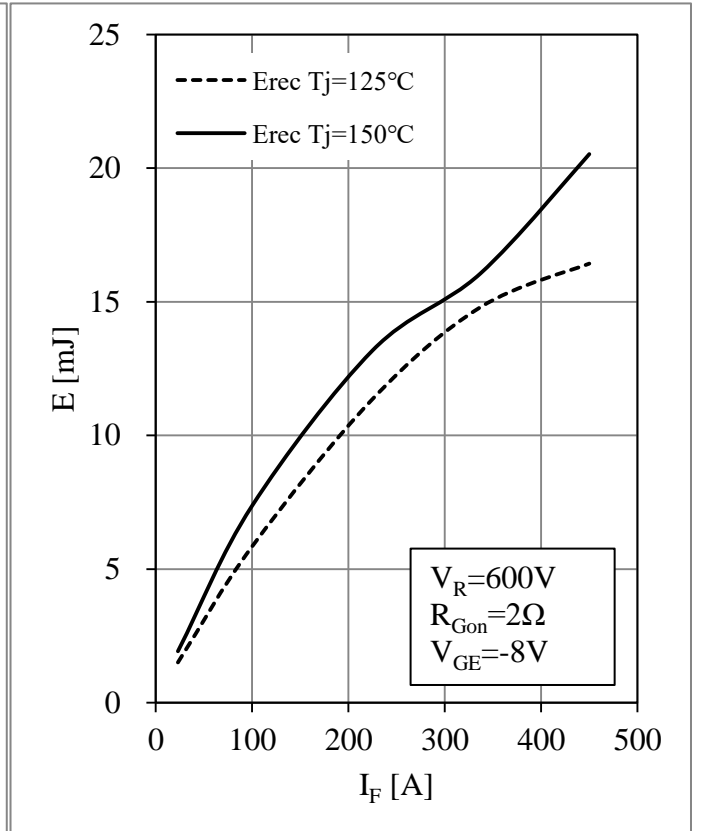


Fig 20. D5/D6 Diode Switching Loss vs.  $I_F$

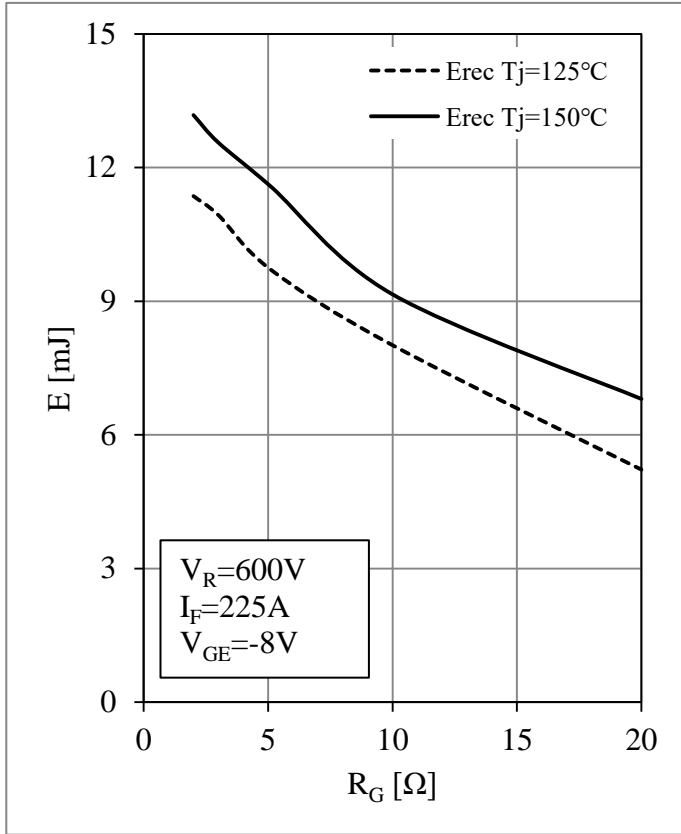


Fig 21. D5/D6 Diode Switching Loss vs.  $R_G$

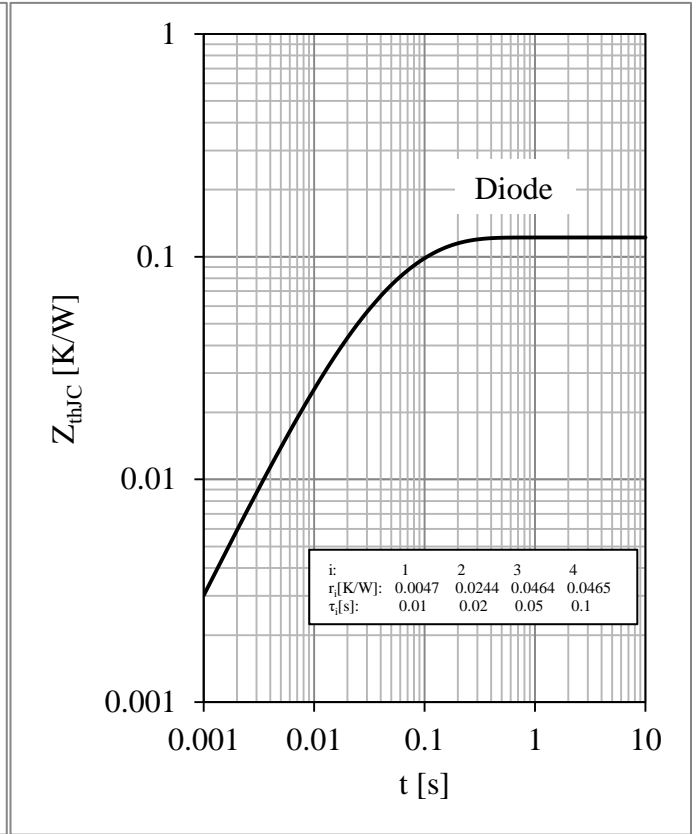


Fig 22. D5/D6 Diode Transient Thermal Impedance

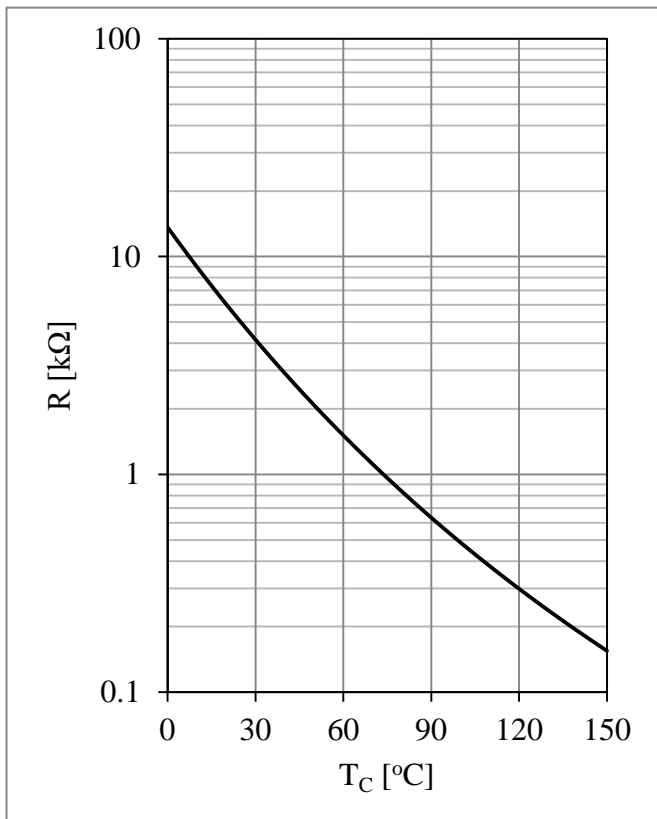
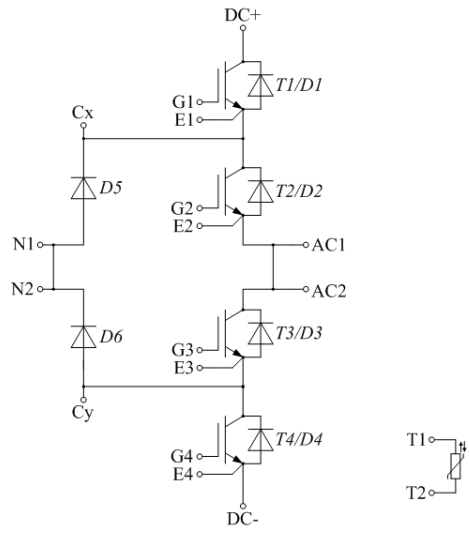


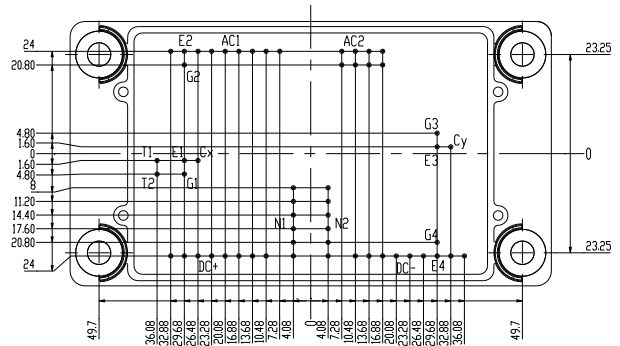
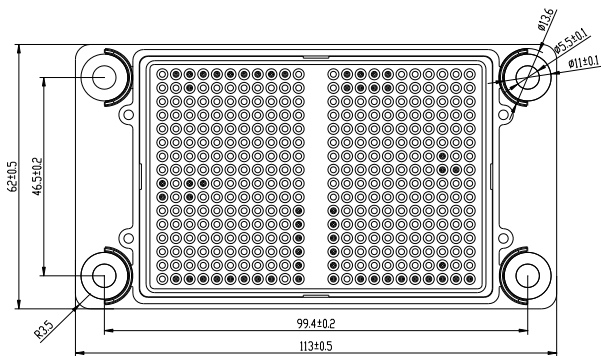
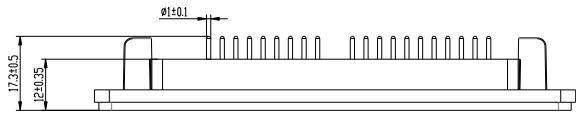
Fig 23. NTC Temperature Characteristic

### Circuit Schematic



### Package Dimensions

Dimensions in Millimeters



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